

♦ STRUCTURE

Silicon Monolithic Integrated Circuit

♦ PRODUCT

SPI BUS 16Kbit (2,048 × 8bit) EEPROM

◇ PART NUMBER

BR25L160-W Series

PART NUMBER	PACKAGE
BR25L160F-W	SOP8
BR25L160FJ-W	SOP-J8
BR25L160FV-W	SSOP-B8
BR25L160FVT-W	TSSOP-B8

♦ FEATURES

Serial Peripheral Interface

Single power supply (1.8V~5.5V)

1,000,000 erase/write cycles endurance

♦ ABSOLUTE MAXIMUM RATING (Ta=25°C)

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc	-0.3∼6.5	٧
Power Dissipation		450 (BR25L160F-W) *1	
	Pd	450 (BR25L160FJ-W) *2	
		300 (BR25L160FV-W) *3	mW
		330 (BR25L160FVT-W) *4	
Storage Temperature	Tstg	−65 ~ 125	°C
Operating Temperature	Topr	-40∼85	°C
Terminal Voltage	_	-0.3∼Vcc+0.3	V

^{*} Degradation is done at 4.5mW/°C (*1,*2), 3.0mW/°C (*3), 3.3mW/°C (*4) for operation above 25°C

♦ RECOMMENDED OPERATING CONDITION

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc	1.8~5.5	٧
Input Voltage	VIN	0~Vcc	٧

Status of this document

The Japanese version of this document is the fomal specification.

A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document, formal version takes priority.



♦ MEMORY CELL CHARACTERISTICS(Ta=25°C, Vcc=1.8~5.5V)

Parameter		1 1			
Parameter		Min.	Тур.	Max.	Unit
Write/Erase Cycle	*1	1,000,000	-	-	Cycle
Data Retention	*1	40		-	Year

Olnitial Data: Memory array FFh, Status Register WPEN:0, BP1:0, BP0:0 *1 Not 100% TESTED

♦ DC OPERATING CHARACTERISTICS

Parameter	Symbol	Specification			Unit	40~85°C, Vcc=1.8~5.5V)
T di difficcor	Cymbol	Min.	Тур.	Max.	5	test condition
"H" Input Voltage1	VIH1	0.7xVcc	ı	Vcc+0.3	>	1.8V≦Vcc≦5.5V
"L" Input Voltage1	VIL1	-0.3	ı	0.3xVcc	٧	1.8V≦Vcc≦5.5V
"L" Output Voltage 1	VOL1	0		0.4	٧	IOL=2.1mA (Vcc=2.5V~5.5V)
"L" Output Voltage2	VOL2	0	1	0.2	٧	IOL=150 μ A (Vcc=1.8V~5.5V)
"H" Output Voltage1	VOH1	Vcc-0.5	-	Vcc	٧	IOH=-0.4mA (Vcc=2.5V~5.5V)
"H" Output Voltage2	VOH2	Vcc-0.2	ı	Vcc	٧	IOH=-100 μ A (Vcc=1.8V~5.5V)
Input Leakage Current	ΙLI	-1	-	1	μА	VIN=0V~Vcc
Output Leakage Current	ILO	-1	ı	1	μА	VOUT=0V∼Vcc , CS=Vcc
Operating Current	ICC1	-	-	1	mA	Vcc=1.8V , fSCK=2MHz , tE/W=5ms
					mA	Byte Write, Page Write, Write Status Register
	ICC2 -			2	mA	Vcc=2.5V , fSCK=5MHz , tE/W=5ms
Write		_	_	2		Byte Write, Page Write, Write Status Register
	ICC3 -		1	3		Vcc=5.5V,fSCK=5MHz,tE/W=5ms
		_			mA	Byte Write, Page Write, Write Status Register
	ICC4	_	-	1.5	mA	Vcc=2.5V,fSCK=5MHz
Operating Current						Read, Read Status Register
Read	1005		-	2	mA	Vcc=5.5V,fSCK=5MHz
	ICC5	-				Read, Read Status Register
	ent ISB		-	2	μА	Vcc=5.5V
Standby Current		-				CS=HOLD=WP=Vcc
						SCK=SI=Vcc or GND, SO=OPEN

OThis product is not designed for protection against radioactive rays.

♦ AC OPERATING CHARACTERISTICS (Unless otherwise specified Ta=-40~85°C, C_L=100pF)

								_
Parameter	Symbol	1.8V≦Vcc≦2.5V			2.5V≦Vcc≦5.5V			Unit
. a. ameter	3,501	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
SCK clock Frequency	fSCK	_	-	2	-	-	5	MHz
SCK High Time	tSCKWH	200	_	-	85	-	-	ns
SCK Low Time	tSCKWL	200	_	-	85	_		ns
CS High Time	tCS	200	-	-	85	_	_	ns
CS Setup Time	tCSS	200	-	_	90	_	_	ns
CS Hold Time	tCSH	200	_	_	85	_	-	ns
SCK Setup Time	tSCKS	200	-	-	90	_	=	ns
SCK Hold Time	tSCKH	200	_	-	90	_	-	ns
SI Setup Time	tDIS	40	-	-	20	_	_	ns
SI Hold Time	tDIH	50	_	-	40	-	_	ns
Output Data Delay Time I	tPD1	_	_	150	-	-	70	ns
Output Data Delay Time2 (C _L =30pF)	tPD2	-	-	145	-	-	55	ns
Output Hold Time	tOH	0	-	-	0	_	_	ns
Output Disable Time	tOZ	_	_	250	-	_	100	ns
Clock High Setup Time before HOLD Active.	tHFS	120	-	-	60	-	_	ns
Clock Low Hold Time after HOLD Active.	tHFH	90	_	-	40	-	-	ns
Clock High Setup Time before HOLD not Active.	tHRS	120	_	-	60	-	_	ns
Clock Low Hold Time after HOLD not Active.	tHRH	140	-	_	70	_	-	ns
HOLD to Output High-Z	tHOZ	_	-	250	-	-	100	ns
HOLD to Output Valid	tHPD	_	_	150	_	-	70	ns
SCK Rise Time *1	tRC	_	_	1	_	-	1	μs
SCK Fall Time *1	tFC	_	_	1	-	-	1	μs
Output Rise Time *1	tRO	_	_	100	_	_	50	ns
Output Fall Time *1	tFO	-	_	100	-	-	50	ns
Write Cycle Time	tE/W	_	-	5	_	-	5	ms
						00/ =		

*1 Not 100% TESTED

♦BLOCK DIAGRAM

CS 1 VOLTAGE 8 Vcc INSTRUCTION DECODE DETECTION CONTROL CLOCK GENERATION WRITE HIGH VOLTAGE SO 2 INHIBITION GENERATOR 7 HOLD INSTRUCTION REGISTER STATUSREGISTE WP 3 ADDRESS ADDRESS 6 SCK REGISTER DECODER 16,384bit EEPROM READ/WRITE REGISTER GND 4 5 SI

Fig.1 BLOCK DIAGRAM

◇ PIN No. / PIN NAME

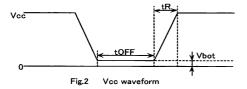
PIN No.	PIN NAME
1	CS
2	SO
3	WP
4	GND
5	SI
6	SCK
7	HOLD
8	Vcc



♦NOTES FOR POWER SUPPLY

In order to prevent an inadvertent write, the device has the feature of P.O.R.

After the power is on, the device is in the write disable mode. P.O.R. works only during power up. The noise may force the device write enable mode with $\overline{\text{CS}}$ ="H"during power ON/OFF. In the case of power up, keep the following conditions to ensure to make the function of P.O.R.



♦ RECOMMENDED CONDITIONS OF tR, tOFF, Vbot							
	tR	tR tOFF					
	Below 10ms Above 10ms		Below 0.3V				
	Below 100ms	Above 10ms	Below 0.2V				

Please keep CS "H" during power ON/OFF.

The device is an active state during \overline{CS} is low. The extraordinary function or data collaption may occur because of noise etc., if power-up is done with \overline{CS} "L". In order to prevent above errors from happening, keep \overline{CS} "H" (=Vcc) during power ON. (The device does not receive any command during \overline{CS} is high.)

It may continue at low Vcc by capacitance of Vcc line during power off.

Please keep CS "H" during power off because of the device may make malfunction and inadvertent write.

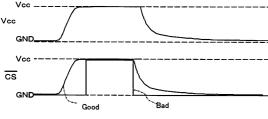


Fig.3 CS TIMING DURING POWER ON/OFF

(Good example)

CS follows Vcc. (CS is pull up to Vcc)

(Bad example)

CS is low during power ON/OFF.

Please take more than 10ms between power ON and power OFF, or the internal circuit is not always reset.

CAUTIONS ON USE

(1) Absolute maximum ratings

If the absolute maximum ratings such as impressed voltage and operating temperature range and so forth are exceeded, LSI may be destructed. Do not impress voltage and temperature exceeding the absolute maximum ratings. In the case of fear exceeding the absolute maximum ratings, take physical safety countermeasures such as fuses, and see to it that conditions exceeding the absolute maximum ratings should not be impressed to LSI.

(2) GND electric potential

Set the voltage of GND terminal lowest at any action condition. Make sure that each terminal voltages is lower than that of GND terminal.

(3) Heat design

In consideration of permissible dissipation in actual use condition, carry out heat design with sufficient margin.

(4) Terminal to terminal shortcircuit and wrong packaging

When to package LSI onto a board, pay sufficient attention to LSI direction and displacement. Wrong packaging may destruct LSI. And in the case of shortcircuit between LSI terminals and terminals and power source, terminal and GND owing to foreign matter, LSI may be destructed.

(5) Strong electromagnetic field

Use in a strong electromagnetic field may cause malfunction, therefore, evaluated design sufficiently.



♦PHYSICAL DIMENSION

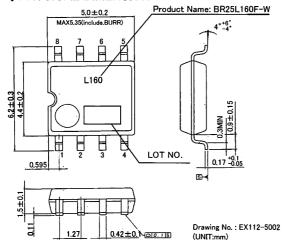


Fig4-(a) PHYSICAL DIMENSION SOP8 (BR25L160F-W)

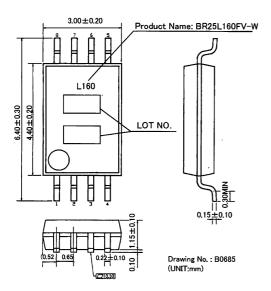


Fig4-(c) PHYSICAL DIMENSION SSOP-B8 (BR25L160FV-W)

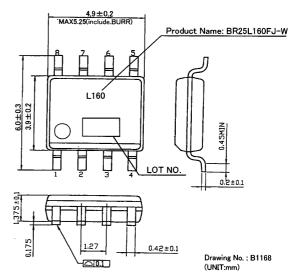


Fig4-(b) PHYSICAL DIMENSION SOP-J8 (BR25L160FJ-W)

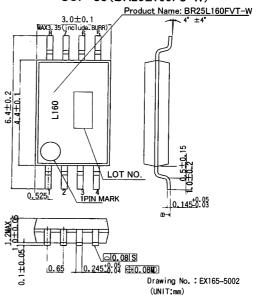


Fig4-(d) PHYSICAL DIMENSION TSSOP-B8 (BR25L160FVT-W)

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U.S.A / San Diego
                        TEL: +1(858)625-3630
                                                 FAX: +1(858)625-3670
       Atlanta
                        TEL: +1(770)754-5972
                                                 FAX: +1(770)754-0691
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                        TEL: +1(972)312-8818
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Germany / Dusseldorf
                        TEL: +49(2154)9210
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United Kingdom / London TEL: +44(1)908-282-666
                                                 FAX: +44(1)908-282-528
France / Paris
                        TEL: +33(0)1 56 97 30 60 FAX: +33(0) 1 56 97 30 80
China / Hong Kong
                        TEL: +852(2)740-6262
                                                 FAX: +852(2)375-8971
       Shanghai
                        TEL: +86(21)6279-2727
                                                 FAX: +86(21)6247-2066
       Dilian
                        TEL: +86(411)8230-8549
                                                 FAX: +86(411)8230-8537
       Beijing
                        TEL: +86(10)8525-2483
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Taiwan / Taipei
                        TEL: +866(2)2500-6956
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Korea / Seoul
                        TEL: +82(2)8182-700
                                                 FAX: +82(2)8182-715
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                        TEL: +65-6332-2322
                                                 FAX: +65-6332-5662
Malaysia / Kuala Lumpur
                        TEL: +60(3)7958-8355
                                                 FAX: +60(3)7958-8377
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                        TEL: +63(2)807-6872
                                                 FAX: +63(2)809-1422
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                        TEL: +66(2)254-4890
                                                 FAX: +66(2)256-6334
```

Japan / (Internal Sales)

Tokyo 2-1-1, Yaesu, Chuo-ku, Tokyo 104-0082

TEL: +81(3)5203-0321 FAX: +81(3)5203-0300

Yokohama 2-4-8, Shin Yokohama, Kohoku-ku, Yokohama, Kanagawa 222-8575

TEL: +81(45)476-2131 FAX: +81(45)476-2128

Nagoya Dainagayo Building 9F 3-28-12, Meieki, Nakamura-ku, Nagoya, Aichi 450-0002

TEL: +81(52)581-8521 FAX: +81(52)561-2173

Kyoto 579-32 Higashi Shiokouji-cho, Karasuma Nishi-iru, Shiokoujidori, Shimogyo-ku,

Kyoto 600-8216

TEL: +81(75)311-2121 FAX: +81(75)314-6559

(Contact address for overseas customers in Japan)

Yokohama TEL: +81(45)476-9270 FAX: +81(045)476-9271